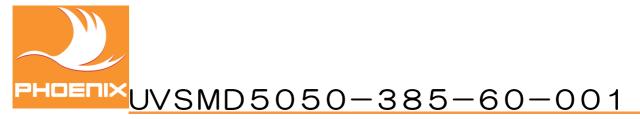
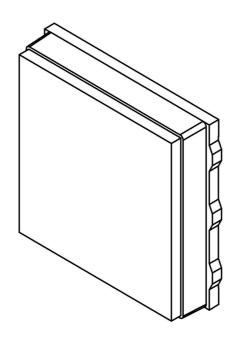
UVSMD5050-385-60-001



385nm HIGH POWER LED



#### **Features**

Chip size: 1.2×1.2mmNumber of Chips: 1pcPeak Wavelength: 385nm

Optical efficiency (typ.): 1080mW

•Viewing half angle: 60°

•Package: SMD Resin package

·Lens: Glass

## **Applications**

- Machine Vision System
- ·Light source for in-vehicle camera
- Infrared data communication

UVSMD5050-385-60-001

## Maximum Ratings (Tc=25°C)

Parameter	Symbol	Values	Unit
Power Dissipation	P <sub>D</sub>	2870	mW
Forward Current	l <sub>F</sub>	700	mA
Pulse Forward Current	I <sub>FP</sub>	1000	mA
Reverse Voltage	$V_R$	5	V
Junction Temperature	Tj	115	°C
Operating Temperature	$T_{opr}$	-40~100	°C
Storage Temperature	$T_{stg}$	-40~100	°C
Thermal Resistance	$R_{thja}$	10	K/W

<sup>※</sup>Pulse Forward Current Condition: Duty 1% and Pulse Width=10us.

# Optical and Electrical Characteristics (Tc=25°C)

Parameter	Symbol	Min	Тур	Max	Unit	<b>Test Condition</b>
Forward Voltage	V <sub>F</sub>		3.6	4.1	V	I <sub>F</sub> =0.7A
	V <sub>FP</sub>		3.75		V	I <sub>FP</sub> =1A
Radiated Power	Po		1080		mW	I <sub>F</sub> =0.7A
			1580		mW	I <sub>FP</sub> =1A
Radiant Intensity	lE		764		mW/sr	I <sub>F</sub> =0.7A
			1120		mW/sr	I <sub>FP</sub> =1A
Peak Wavelength	λр		385		nm	I <sub>F</sub> =0.7A
Half Width	Δλ		12		nm	I <sub>F</sub> =0.7A
Viewing Half Angle	θ 1/2		±60		deg	I <sub>F</sub> =100mA

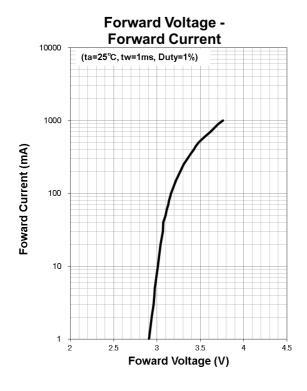
<sup>\*</sup>Radiated Power is measured by S3584-08.

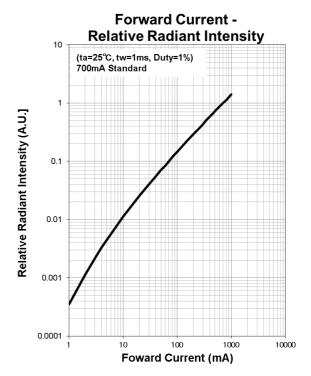
XSoldering condition: Soldering condition must be completed with 10 seconds at below 260℃

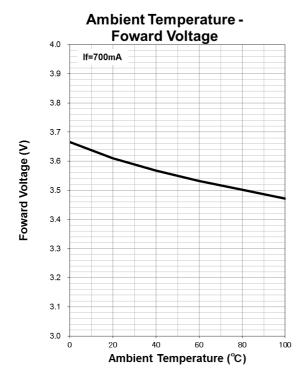
<sup>\*</sup>Radiant Intensity is measured by CIE127-2007 Condition B.

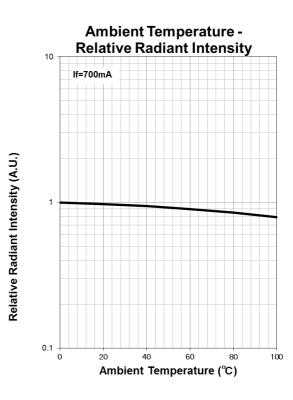
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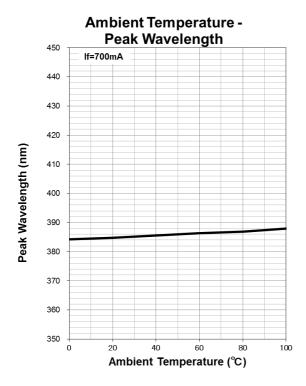
## **Typical Characteristic Curves**

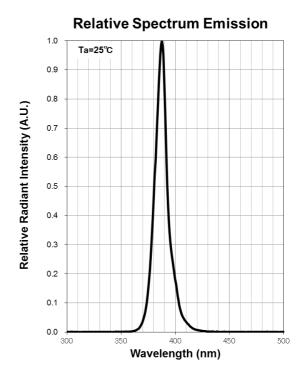


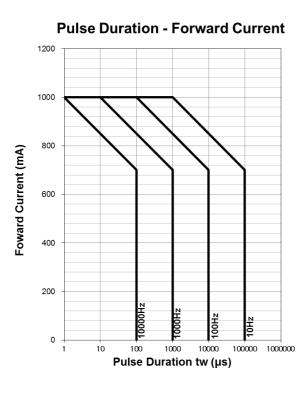


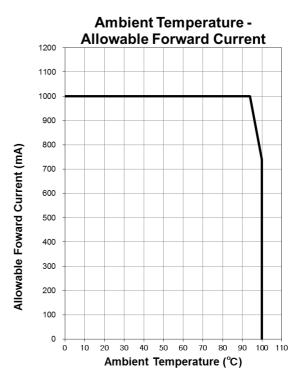




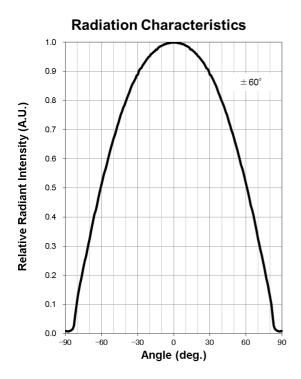






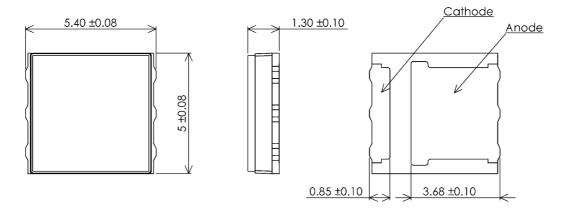


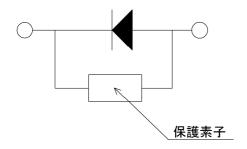
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## UVSMD5050-385-60-001

## **Outline and Internal Circuit**





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#### RECOMMENDED METHODE OF STORAGE AND HANDLING

### **Storage Conditions**

#### Before opening the moisture-proof Aluminum Bag

- Please keep at the condition of < 30°C and < 60% RH</li>
- The maximum storage life is 12 months under these conditions.

#### After opening the moisture-proof Aluminum Bag

- Please store the aluminum bag and silica gel in a drying apparatus.
- The LED should go through the soldering process within 72 hours in a room with the condition of  $5\sim30^{\circ}$ C and < 50% RH.
- Unused remaining LEDs and silica gel should be returned to the original aluminum bag. And please hermetically seal that bag.
- It is recommended to store the re-sealed bag in a drying apparatus at the condition of < 30% RH.
- 72 hours of long floor life does not included the time period which LEDs are stored in the moisture-proof Aluminum Bag. Even though, it is highly recommended to solder the LEDs as soon as after opening the aluminum bag.

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#### **Disclaimer**

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Product data and parameters in this brochure are typical values according to reasonably updated measurements.

Product data and parameters may vary by its application and operating time.

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Aug. 2018